


THREE PHASE CONTROLLED BRIDGE

Power Modules

Features

- Package fully compatible with the industry standard INT-A-pak power modules series
- High thermal conductivity package, electrically insulated case
- Outstanding number of power encapsulated components
- Excellent power volume ratio
- 4000 V_{RMS} isolating voltage
- UL E78996 approved 

55 A
90 A
110 A

Description

A range of extremely compact, encapsulated three phase controlled bridge rectifiers offering efficient and reliable operation. They are intended for use in general purpose and heavy duty applications.

Major Ratings and Characteristics

Parameters	53MT.KB 52MT.KB 51MT.KB	93MT.KB 92MT.KB 91MT.KB	113MT.KB 112MT.KB 111MT.KB	Units
I _o	55	90	110	A
@ T _C	85	85	85	°C
I _{FSM} @ 50Hz	390	950	1130	A
@ 60Hz	410	1000	1180	A
i ² t @ 50Hz	770	4525	6380	A ² s
@ 60Hz	700	4130	5830	A ² s
i ² √t	7700	45250	63800	A ² √s
V _{RRM} range	800 to 1600			V
T _{STG} range	-40 to 125			°C
T _J range	-40 to 125			°C

53-93-113MT..KB Series

Bulletin I27503 08/97



ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V _{RRM} , maximum repetitive peak reverse voltage V	V _{RSM} , maximum non-repetitive peak reverse voltage V	V _{DRM} , max. repetitive peak off-state voltage gate open circuit V	I _{RRM} /I _{DRM} max. @ T _J = 125°C mA
53/52/51MT..KB	80	800	900	800	10
	100	1000	1100	1000	
	120	1200	1300	1200	
	140	1400	1500	1400	
	160	1600	1700	1600	
93/92/91MT..KB 113/112/111MT..KB	80	800	900	800	20
	100	1000	1100	1000	
	120	1200	1300	1200	
	140	1400	1500	1400	
	160	1600	1700	1600	

Forward Conduction

Parameter	53MT.KB 52MT.KB 51MT.KB	93MT.KB 92MT.KB 91MT.KB	113MT.KB 112MT.KB 111MT.KB	Units	Conditions
I _O Maximum DC output current @ Case temperature	55	90	110	A	120° Rect conduction angle
	85	85	85	°C	
I _{TSM} Maximum peak, one-cycle forward, non-repetitive on state surge current	390	950	1130	A	t = 10ms No voltage reappplied
	410	1000	1180		t = 8.3ms
	330	800	950		t = 10ms 100% V _{RRM} reappplied
	345	840	1000		t = 8.3ms
I ² t Maximum I ² t for fusing	770	4525	6380	A ² s	t = 10ms No voltage reappplied
	700	4130	5830		t = 8.3ms
	540	3200	4510		t = 10ms 100% V _{RRM} reappplied
	500	2920	4120		t = 8.3ms
I ² √t Maximum I ² √t for fusing	7700	45250	63800	A ² √s	t = 0.1 to 10ms, no voltage reappplied
V _{T(TO)1} Low level value of threshold voltage	1.17	1.09	1.04	V	(16.7% × π × I _{T(AV)} < I < π × I _{T(AV)}), @ T _J max.
V _{T(TO)2} High level value of threshold voltage	1.45	1.27	1.27		(I > π × I _{T(AV)}), @ T _J max.
r _{T1} Low level value on-state slope resistance	12.40	4.10	3.93	mΩ	(16.7% × π × I _{T(AV)} < I < π × I _{T(AV)}), @ T _J max.
r _{T2} High level value on-state slope resistance	11.04	3.59	3.37		(I > π × I _{T(AV)}), @ T _J max.
V _{TM} Maximum on-state voltage drop	2.68	1.65	1.57	V	I _{pk} = 150A, T _J = 25°C t _p = 400μs single junction
di/dt Max. non-repetitive rate of rise of turned on current	150			A/μs	T _J = 25°C, from 0.67 V _{DRM} , I _{TM} = π × I _{T(AV)} , I _g = 500mA, t _r < 0.5 μs, t _p > 6 μs
I _H Max. holding current	200			mA	T _J = 25°C, anode supply = 6V, resistive load, gate open circuit
I _L Max. latching current	400				T _J = 25°C, anode supply = 6V, resistive load

Blocking

Parameter	53MT.KB 52MT.KB 51MT.KB	93MT.KB 92MT.KB 91MT.KB	113MT.KB 112MT.KB 111MT.KB	Units	Conditions
V_{INS} RMS isolation voltage	4000			V	$T_J = 25^\circ\text{C}$ all terminal shorted $f = 50\text{Hz}$, $t = 1\text{s}$
dv/dt Max. critical rate of rise of off-state voltage (*)	500			V/ μs	$T_J = T_J \text{ max.}$, linear to $0.67 V_{DRM}$, gate open circuit

(*) Available with $dv/dt = 1000\text{V/ms}$, to complete code add S90 i.e. 113MT160KBS90.

Triggering

Parameter	53MT.KB 52MT.KB 51MT.KB	93MT.KB 92MT.KB 91MT.KB	113MT.KB 112MT.KB 111MT.KB	Units	Conditions
P_{GM} Max. peak gate power	10			W	$T_J = T_J \text{ max.}$
$P_{G(AV)}$ Max. average gate power	2.5				
I_{GM} Max. peak gate current	2.5			A	
$-V_{GT}$ Max. peak negative gate voltage	10			V	
V_{GT} Max. required DC gate voltage to trigger	4.0			V	$T_J = -40^\circ\text{C}$
	2.5				$T_J = 25^\circ\text{C}$
	1.7				$T_J = 125^\circ\text{C}$
I_{GT} Max. required DC gate current to trigger	270			mA	$T_J = -40^\circ\text{C}$
	150				$T_J = 25^\circ\text{C}$
	80				$T_J = 125^\circ\text{C}$
V_{GD} Max. gate voltage that will not trigger	0.25			V	@ $T_J = T_J \text{ max.}$, rated V_{DRM} applied
I_{GD} Max. gate current that will not trigger	6			mA	

Thermal and Mechanical Specifications

Parameter	53MT.KB 52MT.KB 51MT.KB	93MT.KB 92MT.KB 91MT.KB	113MT.KB 112MT.KB 111MT.KB	Units	Conditions
T_J Max. junction operating temperature range	-40 to 125			$^\circ\text{C}$	
T_{stg} Max. storage temperature range	-40 to 125			$^\circ\text{C}$	
R_{thJC} Max. thermal resistance, junction to case	0.18	0.14	0.12	K/W	DC operation per module
	1.07	0.86	0.70		DC operation per junction
	0.19	0.15	0.12		120° Rect conduction angle per module
	1.17	0.91	0.74		120° Rect conduction angle per junction
R_{thCS} Max. thermal resistance, case to heatsink	0.03			K/W	Per module Mounting surface smooth, flat and greased
T Mounting torque $\pm 10\%$	to heatsink	4 to 6		Nm	A mounting compound is recommended and the torque should be rechecked after a period of 3 hours to allow for the spread of the compound. Lubricated threads.
	to terminal	3 to 4			
wt Approximate weight	225			g	

53-93-113MT.KB Series

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ΔR Conduction (per Junction)

(The following table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC)

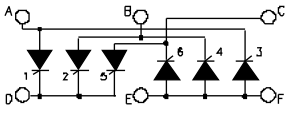
Devices	Sinusoidal conduction @ T_J max.					Rectangular conduction @ T_J max.					Units
	180°	120°	90°	60°	30°	180°	120°	90°	60°	30°	
53/52/51MT.KB	0.072	0.085	0.108	0.152	0.233	0.055	0.091	0.117	0.157	0.236	K/W
93/92/91MT.KB	0.033	0.039	0.051	0.069	0.099	0.027	0.044	0.055	0.071	0.100	
113/112/111MT.KB	0.027	0.033	0.042	0.057	0.081	0.023	0.037	0.046	0.059	0.082	

Ordering Information Table

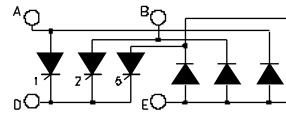
Device Code

11	3	MT	160	K	B	S90
①	②	③	④	⑤	⑥	

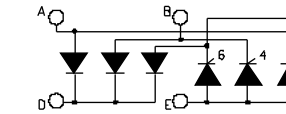
- 1** - Current rating code: 5 = 55 A (Avg)
9 = 90 A (Avg)
11 = 110 A (Avg)
- 2** - Circuit configuration code: 3 = Full-controlled bridge
2 = Positive half-controlled bridge
1 = Negative half-controlled bridge
- 3** - Essential part number
- 4** - Voltage code: Code x 10 = V_{RRM} (See Voltage Ratings Table)
- 5** - Generation II
- 6** - Critical dv/dt: None = 500V/μs (Standard value)
S90 = 1000V/μs (Special selection)



full-controlled bridge
(53, 93, 113MT..KB)



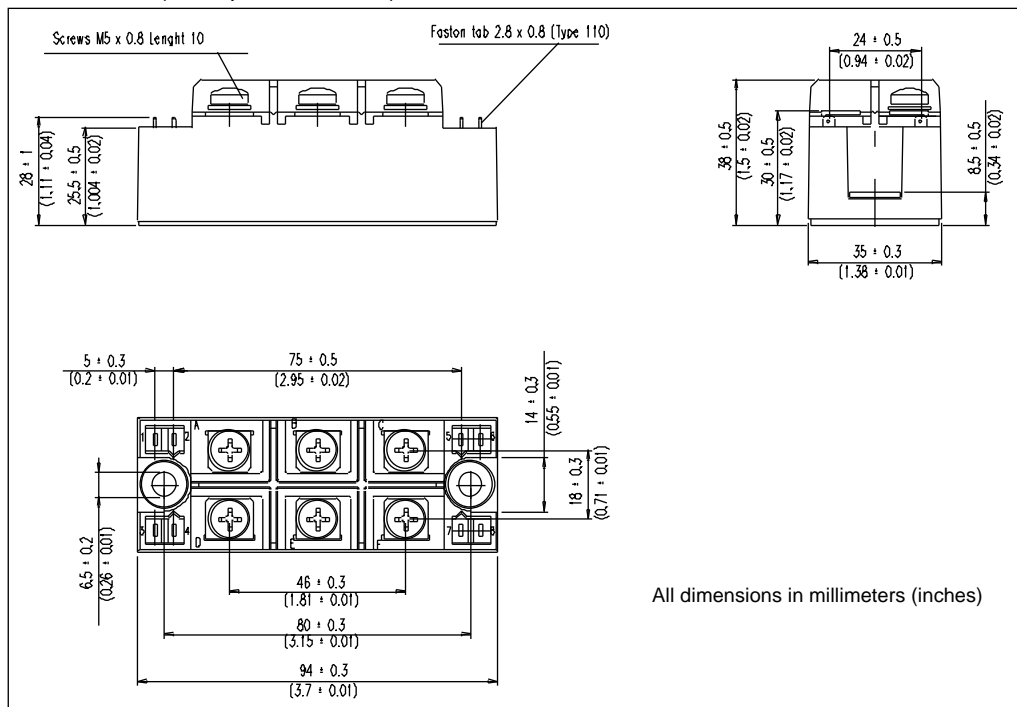
positive half-controlled bridge
(52, 92, 112MT..KB)



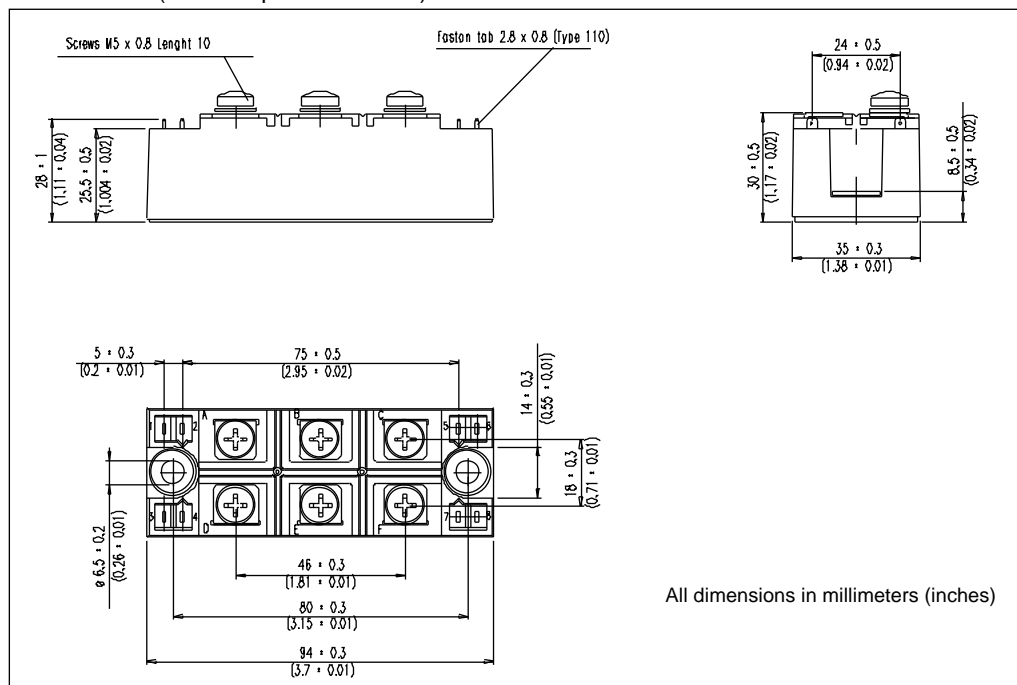
negative half-controlled bridge
(51, 91, 111MT..KB)

NOTE: To order the Optional Hardware see Bulletin I27900

Outline Table (with optional barriers)



Outline Table (without optional barriers)



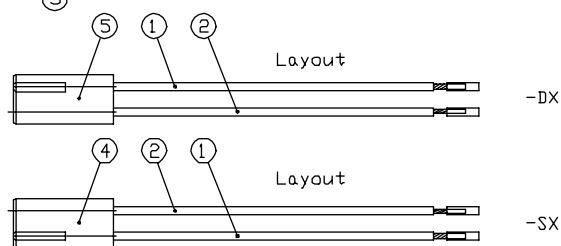
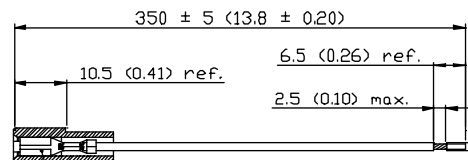
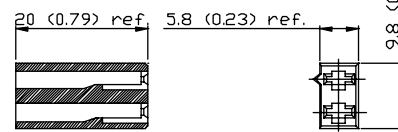
GATE LEADS

Ident No.	Device Series	Description
6443.2112.AA	51, 91, 111MT..KB	2 DX connectors with yellow and white leads
6443.2113.AA	52, 92, 112MT..KB	1 SX + 1 DX connectors with yellow and white leads
6443.2114.AA	53, 93, 113MT..KB 54, 94, 104MT..KB	1 SX + 2 DX connectors with yellow and white leads

Components

- 1) Tinned copper stranded cable, UL 758, Style 1558, AWG 22 (0.32 sqmm) lay 19 x 0.16, ETFE insulation yellow colour, ext. dia. 1.25 mm, temp. rating 125°C.
- 2) Same as point 1, but with white colour insulation. Concerning the configurations in which white cable is requested, it must be connected where is not placed the polarization key.
- 3) Receptacle faston terminal with locking lance, for 2.8 x 0.8 tab (series 110) ref. PN. AMP 150571-2 or equivalent.
- 4) 2 ways polarized connector housing, as shown on dimensional detail (the represented version refers to left 'SX' conn. housing). Raw material: PBT Ciba Crastine SK645FR, black colour.
- 5) Connector housing as point 4), right 'DX' version.

2 ways polarized connector housing, dimensional detail.



All dimensions are in millimeters (inches)

BARRIERS

Ident No. 6444.0211.AA for all MT..KB Series

Barriers Mounting Instructions
Coat uniformly the groove on the plastic box with a silicon adhesive. Insert the barriers into the groove on the plastic box. Cure the silicon adhesive according to its technical notes. We suggest the use of DOW CORNING Silastic 744RTV (time curing 30 min. at room temperature).

All dimensions are in millimeters (inches)

53-93-113MT..KB Series

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International
IRF Rectifier

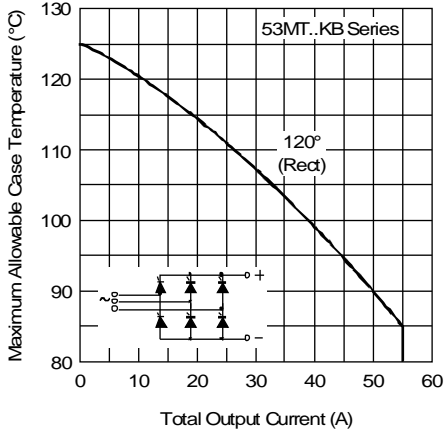


Fig. 1 - Current Ratings Characteristic

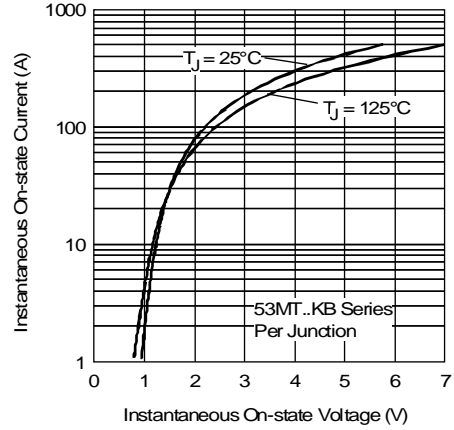


Fig. 2 - Forward Voltage Drop Characteristics

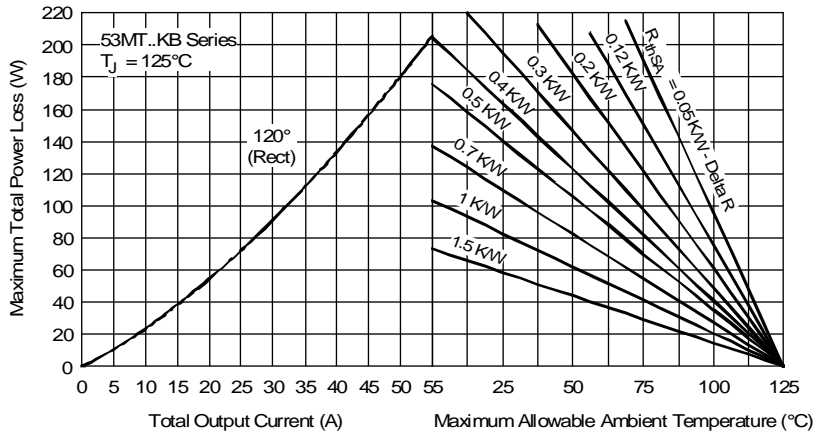


Fig. 3 - Total Power Loss Characteristics

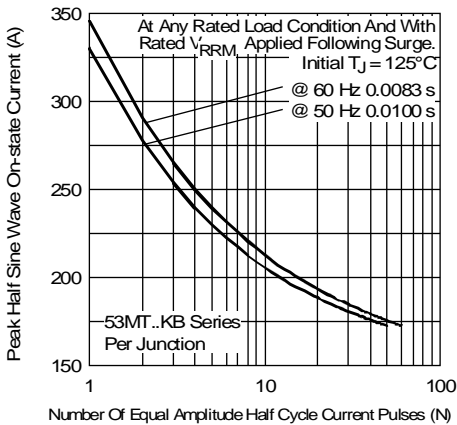


Fig. 4 - Maximum Non-Repetitive Surge Current

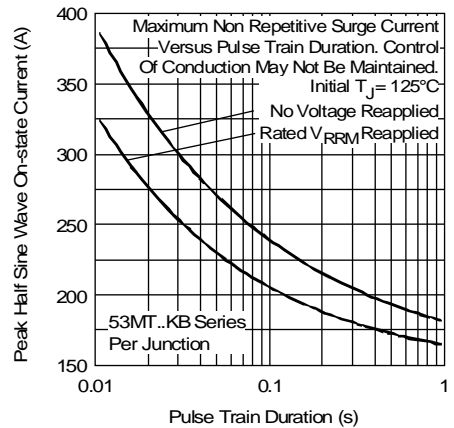


Fig. 5 - Maximum Non-Repetitive Surge Current

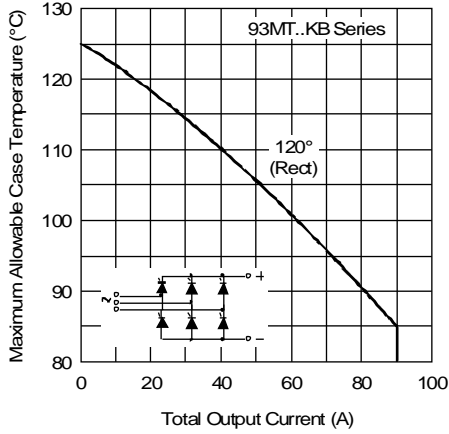


Fig. 6 - Current Ratings Characteristic

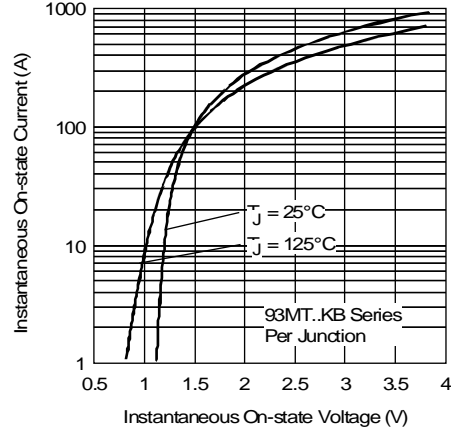


Fig. 7 - Forward Voltage Drop Characteristics

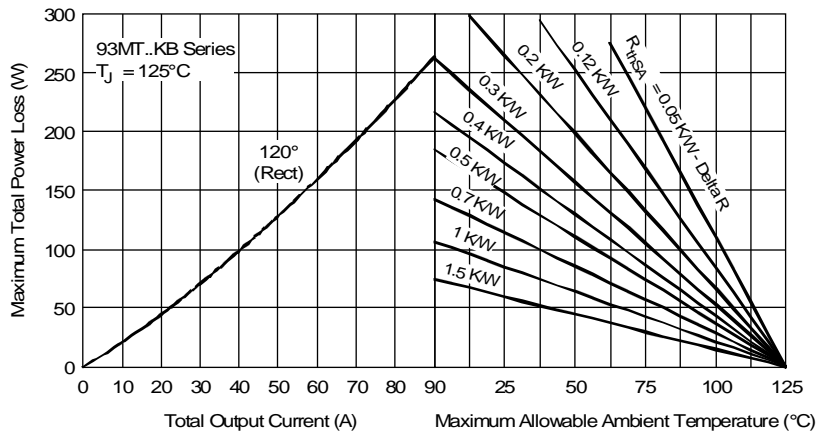


Fig. 8 - Total Power Loss Characteristics

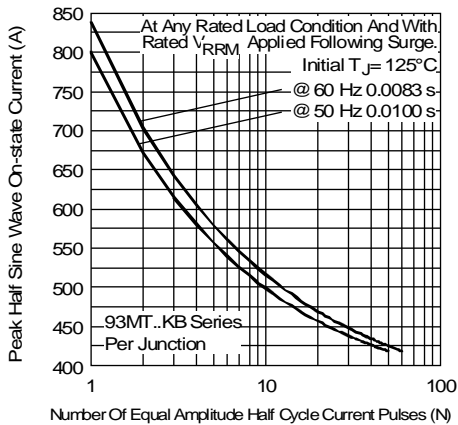


Fig. 9 - Maximum Non-Repetitive Surge Current

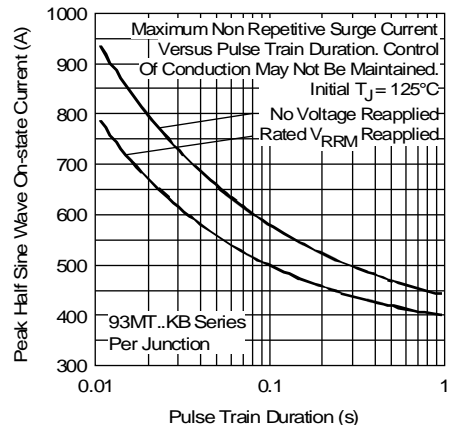


Fig. 10 - Maximum Non-Repetitive Surge Current

53-93-113MT..KB Series

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International
IR Rectifier

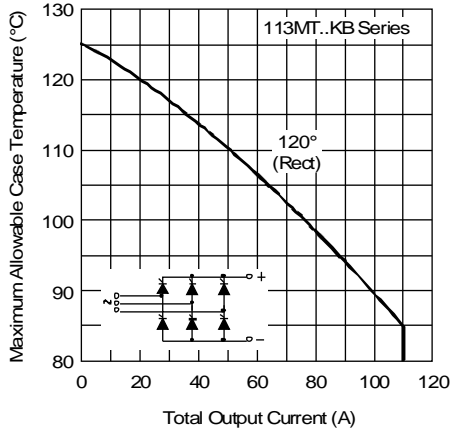


Fig. 11 - Current Ratings Characteristic

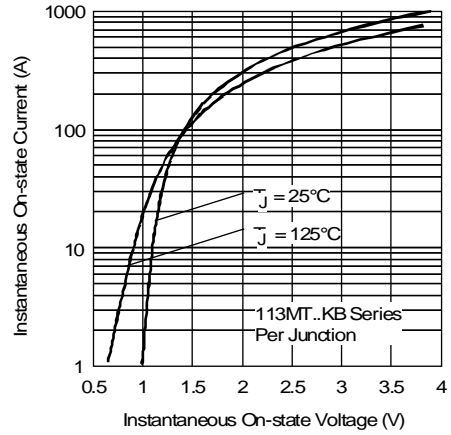


Fig. 12 - Forward Voltage Drop Characteristics

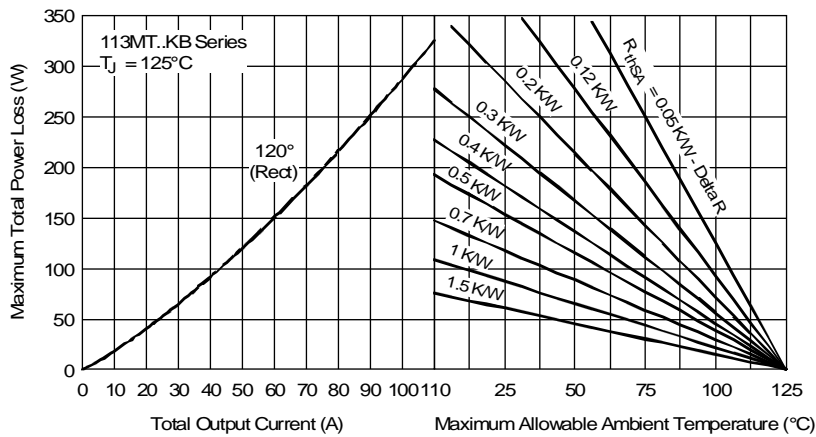


Fig. 13 - Total Power Loss Characteristics

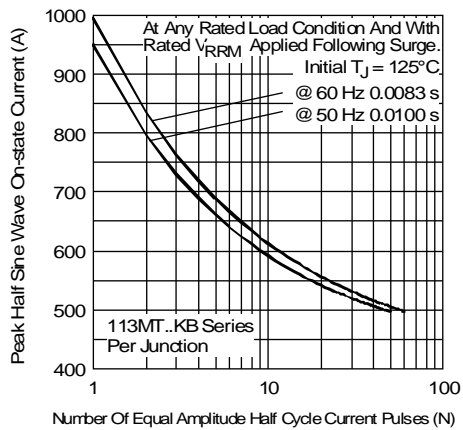


Fig. 14 - Maximum Non-Repetitive Surge Current

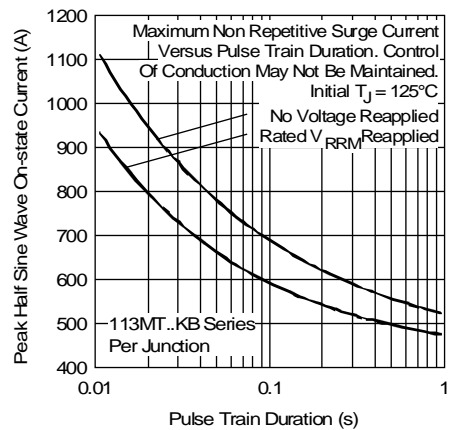


Fig. 15 - Maximum Non-Repetitive Surge Current

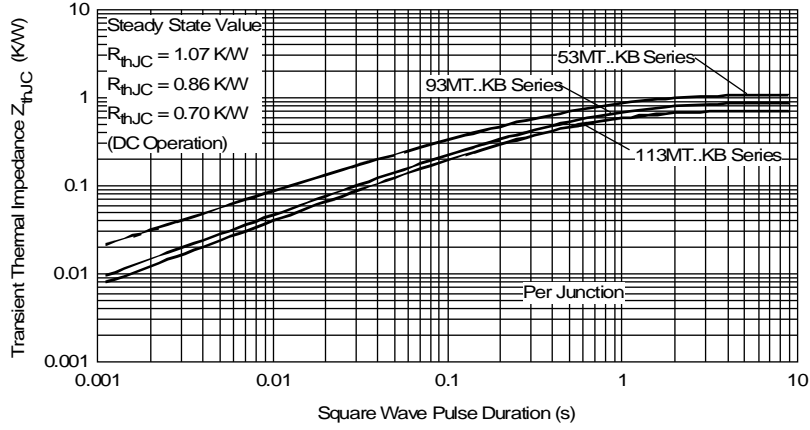


Fig. 16 - Thermal Impedance Z_{thJC} Characteristics

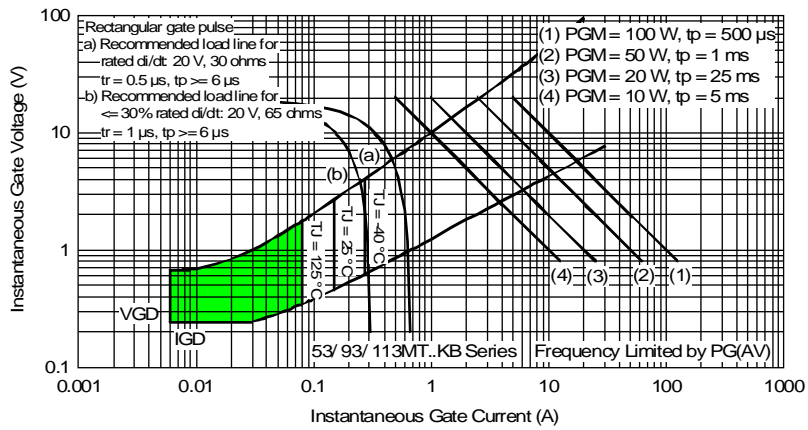


Fig. 17 - Gate Characteristics